DS07-03108-2E

Processor Digital Signal Processor

CMOS

16-bit Fixed-point DSP

MB86330

■ DESCRIPTION

The MB86330 is a 16-bit fixed-point DSP (Digital Signal Processor) that is based on Fujitsu-specific Dual-MAC architecture, and can implement product addition operations and double transfer at a high rate and under low power consumption.

The DSP supports a set of instructions optimum for digital signal processing in communications applications such as handy phones.

The MB86330 consists of a core section and a peripheral section. For detailed specifications of the core section, see MB86330DSP Core Section Specifications.

■ FEATURES

Fixed-point operations

Multiplication: 16 bits \times 16 bits \rightarrow 31 bits Addition: 40 bits + 40 bits \rightarrow 40 bits

Product addition: 40 bits ± 16 bits \times 16 bits \rightarrow 40 bits Maximum operation speed: 100 MIPS at 3.3 V

Memory configuration

Data RAM: Two sectors that can be accessed concurrently

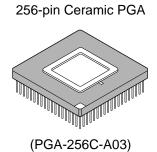
An external RAM (ERAM) is supported.

Memory mapped I/O system characterized by allocation of I/O devices in the memory space

Instruction RAM: 48 Kwords \times 16 bits Table RAM: 16 Kwords \times 16 bits

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■ PACKAGE



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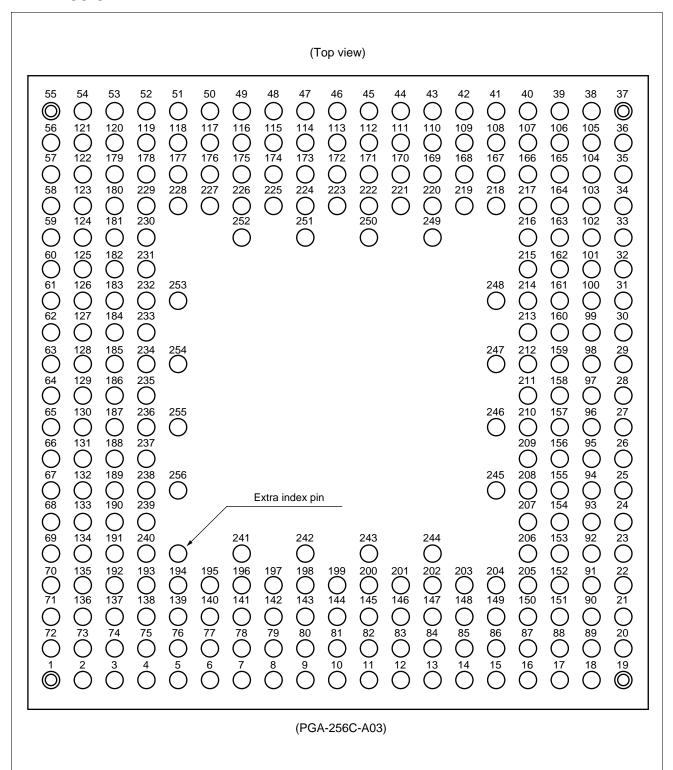
• Addressing

Two independent address units
Eight general-purpose registers
Addressing function that can update a register
Circular addressing
Two address update registers

• Supply voltage: 3.3 V (single type of supply voltage)

• Ceramic package: PGA-256

■ PIN ASSIGNMENT



Pin no.	I/O	Pin name									
1	0	PAO27	33	I/O	ED13	65	0	PAO7	97	I/O	EDI
2	I	ICAD0	34	_	N.C.	66	0	PAO10	98	I/O	ED3
3	0	PAO30	35	I/O	ICDT12	67	0	ST2	99	_	N.C.
4	0	IRO0	36	I/O	ICDT10	68	0	PAO13	100	I/O	ED10
5	0	IRO3	37	I/O	ICDT6	69	0	PAO15	101	I/O	ED12
6	I	ICAD1	38	_	N.C.	70	0	FF	102	I/O	ED15
7	0	IRO8	39	I/O	ICDT3	71	0	PAO21	103	I/O	ICDT13
8	0	IRO10	40	_	N.C.	72	0	PAO23	104	I/O	ICDT11
9	0	IRO14	41	0	AINT6	73	0	PAO24	105	I/O	ICDT9
10	ı	ICAD3	42	0	AINT5	74	0	PAO28	106	I/O	ICDT5
11	0	IRO17	43	I	INT4	75	0	PAO31	107	I/O	ICDT2
12	0	IRO20	44		SCZC	76	0	IRO1	108	0	AINT7
13	0	IRO23	45	_	N.C.	77	0	IRO4	109	I	INT6
14	0	IRO26	46	_	N.C.	78	0	IRO6	110	I	INT5
15	0	IRO28	47	_	N.C.	79	I	ICAD2	111	I	INT3
16	0	IRO30	48	_	N.C.	80	0	IRO13	112		N.C.
17		N.C.	49	I	F0	81	0	IRO16	113		N.C.
18	_	N.C.	50	ı	MOD0	82	0	IRO18	114	I	MCLK
19	0	PAGE1	51	0	AINT2	83	0	IRO21	115	I	BREAK
20	0	XERD	52	0	AINT1	84		N.C.	116	I	MOD2
21	I	WMD0	53	_	N.C.	85	0	IRO27	117	_	N.C.
22	0	EA1	54	_	N.C.	86	_	N.C.	118	I	INT1
23	0	EA4	55	I	SMCK	87		N.C.	119	_	N.C.
24	0	EA5	56	I	SMEN	88	_	N.C.	120	_	N.C.
25	0	EA9	57	0	PDXED	89	0	BTACT	121	_	N.C.
26	0	EA11	58	ı	SYI1	90	0	XEWR	122	_	VS
27	_	N.C.	59	I	SCI1	91	I	WMD1	123	I	SY10
28	0	EA15	60	0	SDO0	92	0	EA2	124	I	SDI1
29	I/O	ED2	61	0	SDO1	93	_	N.C.	125	I	SYO0
30	I/O	ED6	62	0	PAO0	94	0	EA7	126	I	SYO1
31	I/O	ED8	63	0	PAO4	95	0	EA10	127	0	XMONI
32		N.C.	64	I	ICCN	96	0	EA14	128	0	PAO3

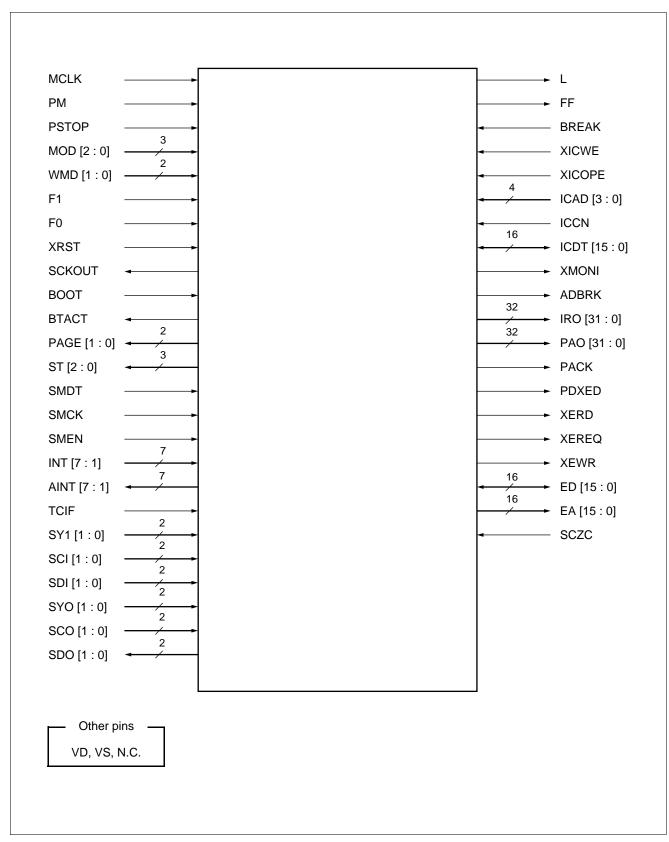
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Pin no.	I/O	Pin name									
129	0	PAO6	161	I/O	ED11	193	0	PAO26	225	_	N.C.
130	0	PAO8	162	I/O	ED14	194	_	VS	226	_	VS
131	0	PAO11	163	I/O	ICDT14	195	_	N.C.	227	_	N.C.
132	0	ST1	164	_	N.C.	196	_	VS	228	_	VS
133	0	PAO14	165	I/O	ICDT8	197	0	IRO7	229	I	SMDT
134	0	PAO17	166	I/O	ICDT4	198	0	IRO11	230	_	VS
135	0	PAO20	167	I/O	ICDT1	199		VS	231	I	SCI0
136	0	PAO22	168	I	INT7	200	_	N.C.	232	_	VS
137	0	PAO25	169	_	N.C.	201	0	IRO24	233	0	ADBRK
138	0	PAO29	170	0	AINT3	201		VS	234	0	PAO1
139	_	N.C.	171	_	N.C.	203	0	IRO31	235	_	VS
140	0	IRO2	172		PSTOP	204		VS	236	I	XICOPE
141	0	IRO5	173	ı	PM	205	0	PAGE0	237	0	ST0
142	0	IRO9	174	ı	F1	206	_	VS	238	_	VS
143	0	IRO12	175	ı	MOD1	207	0	EA0	239	0	PAO18
144	0	IRO15	176	I	INT2	208	_	VS	240	_	VS
145	0	IRO19	177	I	XRST	209	0	EA8	241	_	VD
146	0	IRO22	178	_	N.C.	210	0	EA12	242	_	VD
147	0	IRO25	179	_	N.C.	211	_	VS	243	_	VD
148	0	IRO29	180	ı	TCIF	212	I/O	ED5	244	_	VD
149	_	N.C.	181		SDI0	213	I/O	ED9	245	_	VD
150	_	N.C.	182	I	SCO0	214	_	VS	246	_	VD
151	I	BOOT	183	0	PACK	215	I/O	ICDT15	247	_	VD
152	0	XEREQ	184	I	SCO1	216	_	VS	248	_	VD
153	_	N.C.	185	0	PAO2	217	I/O	ICDT7	249	_	VD
154	0	EA3	186	0	PAO5	218	_	VS	250	_	VD
155	0	EA6	187	0	PAO9	219	I/O	ICDT0	251	_	VD
156	_	N.C.	188	0	PAO12	220	_	VS	252	_	VD
157	0	EA13	189		XICWE	221	0	AINT4	253	_	VD
158	I/O	ED0	190	0	PAO16	222	0	SCKOUT	254	_	VD
159	I/O	ED4	191	0	PAO19	223	_	VS	255	_	VD
160	I/O	ED7	192	0	L	224	_	N.C.	256	_	VD

N.C.: Pin not connected

■ EXTERNAL PIN LAYOUT



■ PIN DESCRIPTION

Pin no.	Pin name	Bit	I/O	Active	Pull up or pull down	Function				
114	MCLK	1	I	_	_	Master clo	ck input			
						MCLK SCKout (Internal sy clock)	vstem	1 machine	cycle	\ _
173	PM	1	I	_	Pull up	Internal m 0: MCLK,			n be selected	
172	PSTOP	1	I	Н	_	PLL opera 0: PLL ope				
50,	MOD	3	I	_	Pull down	Operating	mode			
116, 175	[2:0]					MOD2	MOD1	MOD0	Operating mode	
						0	0	0	Single chip mode	
						Oth	er than ab	oove	Disabled	
21, 91	WMD	2	I	_	Pull down	External memory WAIT mode		}		
91	[1:0]					WMD1	SMD0	Wait cycle	Can data b)e ?
						0	0	0 сус	No	
						0	1	5 сус	No	
						1	0	15 cyc	Yes	
						1	1	30 сус	Yes	
174	F1	1	I	_	_	Flag input	1 (level s	ense)		
49	F0	1	I	_	_	Flag input	0 (level s	ense)		
177	XRST	1	I	L	_	Reset inpu	ut			
222	SCKOUT	1	0	_	_	Internal sy	stem cloc	k output		
44	SCZC	1	I	Н	Pull down	Hi-z contro [15:0] (SC		KOOUT, I	POUT and EA	
151	BOOT	1	I	Н	_	Input for a	BOOT m	ode contro	ol signal	
89	BTACT	1	0	Н	_	Output for signal	a BOOT	mode stat	us indication	
19, 205	PAGE [1:0]	2	0	_	_	Output for selection of			y/page	
67, 132, 237	ST [2:0]	3	0	_	_	Internal st	atus outpi	ut		

Pin no.	Pin name	Bit	I/O	Active	Pull up or pull down	Function
229	SMDT	1	I	_	_	Serial input data (16 bits) for operating mode (SMODE) setup
55	SMCK	1	ı	_	_	Serial input clock for operating mode (SMODE) setup
56	SMEN	1	I	Н	_	Pulse input for operating mode (SMODE) setup Upon completion of setup, a positive pulse is entered.
43, 109 to 111, 118, 168, 176	INT [7:1]	7	I	L	Pull up	Input for INT7 to INT1 interrupt request signals
41, 42, 51, 52, 108, 170, 221	AINT [7:1]	7	0	L	_	Output for INT7 to INT1 interrupt acknowl edge signals
180	TCIF	1	I	Н	_	Used for DC setup. "0": PCM, "1": TCH Used to set serial port 1.
58, 123	SYI [1:0]	2	I	Н	_	Input pins for synchronization signals for serial input port 1/0
59, 231	SCI [1:0]	2	I	_	_	Clock input for serial input port 1/0
124, 181	SDI [1:0]	2	I	_	_	Data input for serial input port 1/0
125, 126	SYO [1:0]	2	I	Н	_	Synchronization signal input for serial output port 1/0
182, 184	SCO [1:0]	2	I	_	_	Clock input for serial output port 1/0
60, 61	SDO [1:0]	2	0	_	_	Data output for serial output port 1/0
192	L	1	0	_	_	PLL status output
70	FF	1	0	_	_	Output for test
115	BREAK	1	I	L	Pull up	Break input for the emulator
189	XICWE	1	I	L	Pull up	Input for an emulator write signal
236	XICOPE	1	I	L	Pull up	Input for an emulator read signal
2, 6, 10, 79	ICAD [3:0]	4	I	_	Pull down	Address input for the emulator
64	ICCN	1	ı	Н	Pull down	Input for an emulator connection signal
35 to 37,39, 103 to 107, 163, 165 to 167, 215, 217, 219	ICDT [15:0]	16	I/O	_	Pull down	I/O for a data bus used to access the emulator
127	XMONI	1	0	L	_	Output for indicating emulator monitor mode status
233	ADBRK	1	0	Н	_	Output for indicating occurrence of an ADBKP register event for the emulator

Pin no.	Pin name	Bit	I/O	Active	Pull up or pull down	Function
4, 5, 7 to 9, 11 to 16, 76 to 78, 80 to 83, 85, 140 to 148, 197, 198, 201, 203	IRO [31:0]	32	0	_	_	Instruction register output for the emulator
1, 3, 62, 63, 65, 66, 68, 69, 71 to 75, 128 to 131, 133 to 138, 185 to 188, 190, 191, 193, 234, 239	PAO [31:0]	32	0	_	_	Program address output for the emulator
183	PACK	1	0	_	_	Output for a PAO fetch clock for the emulator
57	PDXED	1	0	_	_	Output for test
20	XERD	1	0	L	_	Output for an ERAM reading signal
152	XEREQ	1	0	L	_	Output for an ERAM access request signal
90	XEWR	1	0	L	_	Output for an ERAM writing signal
29 to 31, 33, 97, 98, 100 to 102, 158 to 162, 212, 213	ED [15:0]	16	I/O	_	Pull up	External data bus I/O pins
22 to 26, 28, 92, 94 to 96, 154, 155, 157, 207, 209, 210	EA [15:0]	16	0	_	_	Output for the ERAM address
241 to 256	VD	_	_	_	_	Power supply for the digital circuit (3.3 V, input)
122, 194, 196, 199, 202, 204, 206, 208, 211, 214, 216, 218, 220, 223, 226, 228, 230, 232, 235, 238, 240	VS		_	_	_	GND (input) for the digital circuit
17, 18, 27, 32, 34, 38, 40, 45 to 48, 53, 54, 84, 86 to 88, 93, 99, 112, 113, 117,119 to 121, 139, 149, 150, 153, 156, 164, 169, 171, 178, 179, 195, 200, 224, 225, 227	N.C.			_	_	Pins not connected

■ HANDLING DEVICES

1. Take Care So that the Maximum Rated Value Is Not Exceeded. (Preventing Latchup)

Latchup may occur on CMOS ICs if voltage higher than VD or lower than VS is applied to input and output pins other than medium- and high-voltage pins or if higher than the voltage which shows on "1. Absolute Maximum Ratings" in section "■ Electrical Characteristics" is applied between VD and VS.

When latchup occurs, power supply current increases rapidly and might thermally damage elements. When using, take great care not to exceed the absolute maximum ratings.

2. Treatment of Unused Input Pins

Leaving unused input pins open could cause malfunctions. They should be connected to a pull-up or pull-down resistor.

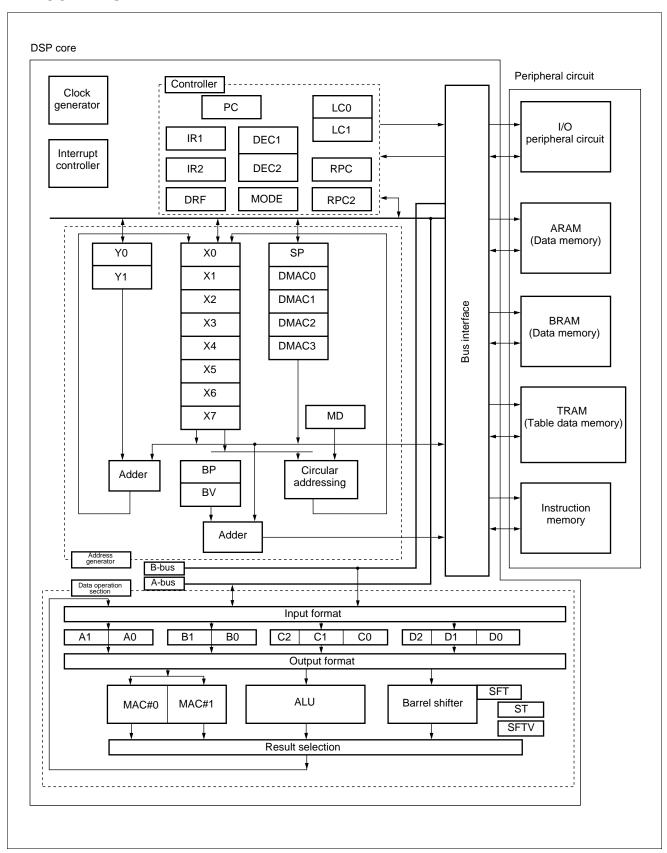
3. Treatment of N.C. Pins

Be sure to leave (internally connected) N.C. pins open.

4. Treatment of Pins Connected to Pull-up/Pull-down Resistors

With neither a pull-up resistor nor a pull-down resistor connected, the pin state is determined depending on the input level that reflects an internal resistor. When controlling the pin state, however, connect a pull-up or pull-down resistor.

■ BLOCK DIAGRAM



■ DESCRIPTION OF BLOCK FUNCTIONS

• Clock generator (CLOCK Gen.)

Generates a clock required for the DSP to control a system clock stop in the waste state and an entire clock stop for sleeping.

Interrupt controller

Controls an INT interrupt, an overflow interrupt, and a DMA interrupt.

Controller

Generates a program address and decodes an instruction to control the entire DSP.

· Address generator

Generates an address required for memory access. It supports a circular addressing function to control the DMA access pointer and the stack pointer.

· Data operation section

Performs data operations such as product addition, arithmetic operations (multiplication, division, addition and subtraction), logic operations, and shift operations.

Bus interface

Controls access to the memory space including instruction reading, data memory access and mapped I/O access.

ARAM/BRAM

This is a data memory for data operations. A and B use different banks, enabling double transfer without a wait. (ARAM = 4 kwords, BRAM = 4 kwords)

TRAM (Table data memory)

Sets table data required for applications.

• Instruction memory

Sets program data.

Mapped I/O

Supports a macro valid for applications

Serial I/O: Two serial ports for transmitting CODEC data.

One serial input 1 system for setting operating mode (SMODE)

■ MEMORY SPACE

Configuration of the memory space

The memory space consists of a data memory space and an instruction memory space. The I/O, ARAM, BRAM, TABLE, and ERAM (external memory) areas are allocated in the data memory space, while the instruction memory is allocated in the program memory space. The I/O, TABLE, ERAM (external memory), ARAM and BRAM areas in the data memory space are, however, assigned a particular data bus. The memory for any two areas can, therefore, be accessed concurrently during one cycle. What memory is accessed is determined automatically by an address value.

Addresses allocated for the memories, and their maximum size are determined as follows. Select a memory size to be allocated in this range.

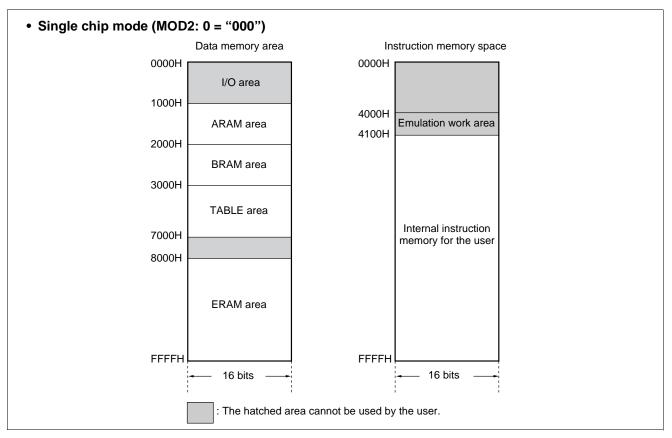
• Memory space mode

You can select a method for allocating the data memory space and the program memory space by operating mode. Determine operating mode by mode pins (MOD2, MOD1 and MOD0) as follows.

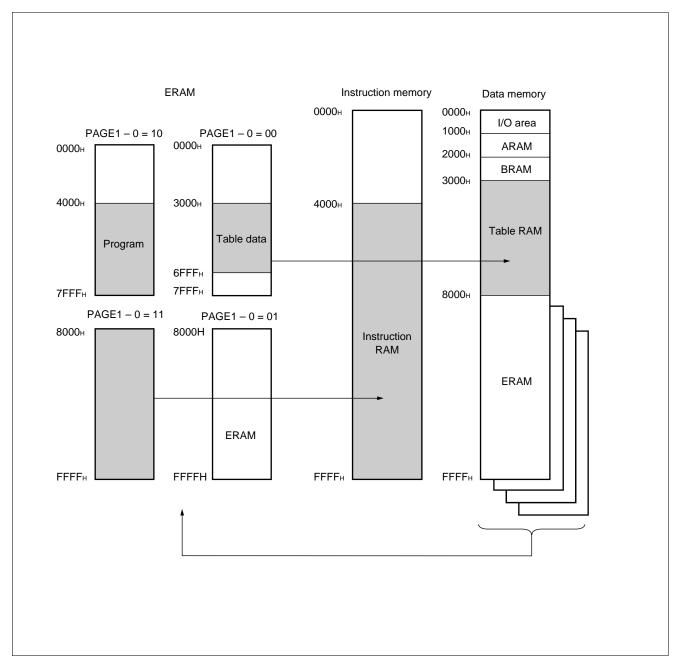
MOD2	MOD1	MOD0	Operating mode
0	0	0	Single chip mode
	Other than above	9	Disabled

• Memory map for single chip mode

The program for single chip mode (MOD2: 0 = "000") is operated by the internal program RAM (which externally downloads a program). Five areas for I/O, ARAM, BRAM, TABLE and ERAM are allocated on the data memory space, with the instruction memory allocated on a program memory space completely different from the data memory space. Although the instruction memory can have an independent address space for 64 kwords, therefore, you cannot access data in the instruction memory using a program.



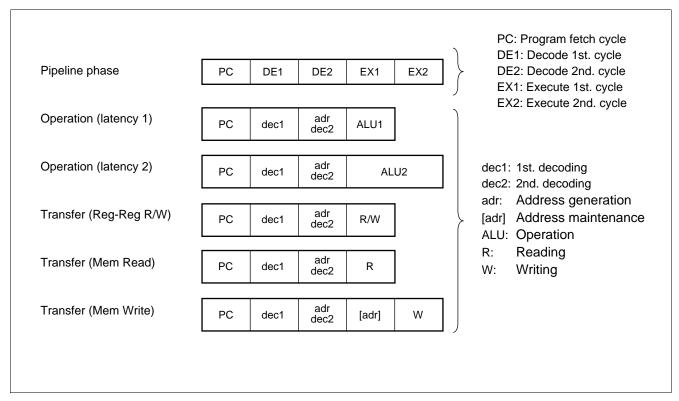
■ MEMORY MAP FOR BOOT STRAP



The ERAM area is used by the DSP to access the data memory space. Because the ERAM area ranges from 8000^H to FFFFH, however, PAGE is created in units of 32 kwords. PAGE is selected automatically.

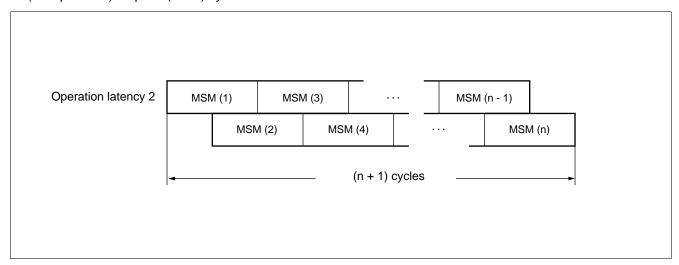
■ BASIC PIPELINE OPERATION

The DSP splits the contents of processing in one cycle to increase the number of pipeline sectors for high-speed operation. For operations using product adders such as product addition and multiplication, and for operations using 40-bit adders such as 40-bit addition, the processing latency is two cycles.



■ PRODUCT ADDITION

For product addition and multiplication, the latency is two cycles. Because it is provided with a dual product adder (MAC) for alternate processing every cycle, however, the DSP can process n successive product addition (multiplication) steps in (n + 1) cycles.



■ REGISTER TABLE

Register name	Bit length	Register type	Initial value	Register configuration
A0	16	Data register	Undefined	bit 31 bit 16 bit 15 bit 0
A1	16	Data register		A1 A0 AX
AX	32	Data register		
В0	16	Data register		bit 31 bit 16 bit 15 bit 0
B1	16	Data register		B1 B0 BX
вх	32	Data register	-	
C0	16	Accumulator	Undefined	
C1	16	Accumulator		
C2	8	Accumulator (guard register)		bit 39 bit 32 bit 31 bit 16 bit 15 bit 0 C2 C1 C0 CX
CX	40	Accumulator		
D0	16	Accumulator	-	bit 39 bit 32 bit 31 bit 16 bit 15 bit 0
D1	16	Accumulator		D2 D1 D0 DX
D2	8	Accumulator (guard register)		
DX	40	Accumulator		
X0	16	Address register	Undefined	
X1	16	Address register	-	bit 15 bit 0 bit 15 bit 0
X2	16	Address register	-	Y0 X0
Х3	16	Address register	-	Y1 X1
X4	16	Address register	-	X2
X5	16	Address register	-	X3
X6	16	Address register	-	X4
X7	16	Address register	1	X5
Y0	16	Address register update register		X6 X7
Y1	16	Address register update register		

Register name	Bit length	Register type	Initial value	Register configuration
BP	16	Base pointer	Undefined	
BV	16	Circular register		
MD	16	Modulo register		bit 15 bit 0 bit 15 bit 0
RPC	16	Repeat counter 1		BV ST
RPC2	16	Repeat counter 2		MD bit 15 bit 0
DOSTR	16	DO start address register		RPC DRF
DOEND	16	DO end address register		RPC2 bit 5 bit 0 DOSTR SFT
LC0	16	Loop counter		DOEND
LC1	16	Loop counter		LC0
SFT	6	Shift register		LC1
SFTV	16	Shift register		bit 15 bit 0
ST	16	Status register	0000000в	SFTV
MODE	16	Mode register	0000000в	
DRF	16	Flag holding register		
DMAC0	16	DMA counter	Undefined	
DMAC1	16	DMA counter		bit 15 bit 0 bit 15 bit 0
DMAC2	16	DMA counter		PC DMACO
DMAC3	16	DMA counter		SP DMAC1 DMAC2
PC	16	Program counter	FFFD	DMAC2
SP	16	Stack pointer	Undefined	Divinos

■ REGISTERS

Data registers (A0, A1, B0 and B1)

Each of the data registers consists of four words (16 bits). They can be used as four word-length registers (16 bits) and two long-word registers (32 bits) to execute various arithmetic operation instructions, logic operation instructions, and transfer instructions.

• Accumulators (C0 to C1, and D0 to D2)

The accumulators can be linked as two 40-bit registers (CX and DX) to execute various arithmetic operation instructions, logic operation instructions, and transfer instructions. The 40-bit length registers (CX and DX) can be specified as destinations for product addition instructions. Four 16-bit length accumulators (C0, C1, D0 and D1), and two 8-bit length accumulators (C2 and D2) are supported.

Address registers (X0 to X7)

Eight 16-bit address registers are supported. An address register is used to specify an operand address for transfer. Immediate values (1 to –2) or the address update registers (Y0 and Y1) can be used to update address registers. They can also be updated automatically by transfer.

Address update registers (Y0 and Y1)

Two 16-bit address update registers are supported. The address update registers are used to update address registers during addressing.

Base pointer (BP)

The base pointer consists of 16 bits. The contents of the base pointer plus a 7-bit immediate value are generated as the address value during direct 7-bit length addressing.

Circular register (BV)

The circular register, which consists of 16 bits, provides an offset value for circular addressing.

• Modulo register (MD)

The modulo register, which consists of 16 bits, is used to specify an addressing range for circular addressing.

• Repeat counter (RPC)

The repeat counter, which consists of 16 bits, is used to specify the number of times the REP/DO instruction is repeated. During execution of the repeat instruction, the repeat counter is decremented by one every repeat operation cycle.

• Repeat counter 2 (RPC2)

Repeat counter 2, which consists of 16 bits, is used to specify the number of times the REP2 instruction is repeated. During execution of the repeat 2 instruction, repeat counter 2 is decremented by one every repeat operation cycle.

DO address registers (DOSTR and DOEND)

These registers maintain a loop start address (DOSTR)/end address (DOEND) for the DO instruction. They can process only PUSH/POP.

• Loop counters (LC0 and LC1)

Each of the loop counters consists of 16 bits. They store the number of times repetition is made in a specified address range.

(Continued)

Shift register (SFT)

The SFT register consists of signed 6 bits. This shift value storage register stores the number of bits shifted during execution of the shift instruction.

• Shift register (SFTV)

The SFTV register, which consists of 16 bits, is used to store the results of CMLT and CMGT instruction.

• Status register (ST)

The status register, which consists of 16 bits, is assigned bits for storing information about results of operations (carry and overflow) and for setting operating mode.

• Mode register (MODE)

This register is used to specify modes of operations and transfer, and interrupts.

• Flag holding register (DRF)

This register holds flags for the DO, REP and REP2 instructions. It can process only PUSH/POP. This register is cleared by the PUSH instruction.

• DMA counters (DMAC0 to DMAC3)

When a DMA interrupt occurs, this register stores the address of the data transfer source or the data transfer destination.

Program counter (PC)

The program counter, which consists of 16 bits, points to the memory address that stores an instruction code to be executed by the CPU. While it is updated automatically by instruction execution, the program counter can be rewritten by a conditional branch, a subroutine call instruction, an interrupt, and a reset. Executing the repeat instruction stops a program counter update.

• Stack pointer (SP)

The stack pointer, which consists of 16 bits, stores addresses for saving and transferring the contents of registers upon execution of the PUSH/POP instruction, the subroutine call instruction, or an interrupt.

■ DETAILED DESCRIPTION OF SPECIAL REGISTERS

(1) Status Register

bit 15	bit 14	bit 13	bit 12	bit 11	bit 10	bit 9	bit 8	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
IT	OV3	OV1	INT2	INT1	INT0	MDMA	СР	RND	ITG	V3	V2	V1	N	Z	С

Bit abbreviation	Bit name	Description
С	Carry flag	Set when carry occurs as a result of operation execution. Reset when no carry occurs. Not changed by transfer instruction execution.
Z	Zero flag	Set when the operation result is 0. Reset when the operation result is not 0. Not changed by transfer instruction execution.
N	Negative flag	Set when the operation result is smaller than 0. Reset when the operation result is equal to or greater than 0. Not changed by transfer instruction execution.
V1	Overflow flag 1	Set when the operation result overflows. Reset when the operation result does not overflow. Not changed by transfer instruction execution.
V2	Overflow flag 2	Set when the operation result overflows. Set V2 is reset only by hardware or by ST programming by the transfer instruction. Not changed by transfer instruction execution.
V3	Overflow flag 3	Set when the operation result of an instruction stored in CX or DX cannot be expressed by 32 bits (but by 40 bits). Reset when the operation result can be expressed by 32 bits.
ITG	Operating mode specification flag	Specify this when executing multiplication in integral mode.
RND	Rounding mode setup	Used to set ON/OFF of rounding processing when data is transferred from a register consisting of 32 or more bits to a 16-bit register.
СР	Clip flag	Used to specify whether the operation result is to be clipped when overflow occurs during the operation.
MDMA	DMA enable flag	Enables a DMA interrupt. (0: Disabled)
INT0	Interrupt enable flag	INT0 (SMODE) interrupt enable flag 0: Disabled, 1: Enabled
INT1	Interrupt enable flag	INT1 interrupt enable flag 0: Disabled, 1: Enabled
INT2	Interrupt enable flag	INT2 interrupt enable flag 0: Disabled, 1: Enabled
OV1	V1 interrupt enable flag	Operation overflow interrupt enable flag. An interrupt is generated when V1 is set. 0: An interrupt is disabled. 1: An interrupt is enabled.
OV3	V3 interrupt enable flag	Operation overflow interrupt enable flag. An interrupt is generated when V3 is set. 0: An interrupt is disabled. 1: An interrupt is enabled.
IT	Interrupt enable flag	OV1, OV3 and INT0 to INT7 interrupt enable flag 0: An interrupt is disabled. 1: An interrupt is enabled.

(2) Mode Register

_	bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
	INT7	INT6	INT5	INT4	INT3	_	NCT	NOG

Bit abbreviation	Bit name	Description
NOG	Operating mode specification	O: Ordinary mode The guard bit is used. 1: NOG mode No guard bit is used.
NCT	Transferred data clipping specification	Transferred data is clipped. Transferred data is not clipped.
_	Indeterminate	Reserved
INT3	Interrupt enable flag	INT3 interrupt enable flag 0: Disabled, 1: Enabled
INT4	Interrupt enable flag	INT4 interrupt enable flag 0: Disabled, 1: Enabled
INT5	Interrupt enable flag	INT5 interrupt enable flag 0: Disabled, 1: Enabled
INT6	Interrupt enable flag	INT6 interrupt enable flag 0: Disabled, 1: Enabled
INT7	Interrupt enable flag	INT7 interrupt enable flag 0: Disabled, 1: Enabled

(3) DRF Register

bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
REPF23	REPF22	REPF21	REPF13	REPF12	REPF11	DOF1	DOF2

Bit abbreviation	Bit name	Description
DOF2	DO flag 2	Internal operation status holding flag.
DOF1	DO flag 1	Only PUSH and POP are available. Cleared by the PUSH instruction.
REPF11	REP1 flag 1	
REPF12	REP1 flag 2	
REPF13	REP1 flag 3	
REPF21	REP2 flag 1	
REPF22	REP2 flag 2	
REPF23	REP2 flag 3	

■ ADDRESSING

• Types of addressing

When reading/writing data from/to the memory, you can use a direct addressing method for specifying a 16-bit length address space with an immediate value, and an indirect addressing method for referencing that space by an address register. The DSP supports eight address registers, two update registers, the base pointer, the circular register, and the modulo register for addressing.

· Addressing classification

Three indirect addressing means (AD0 to AD2) by address registers can be used to transfer a register value to a memory, data from a memory to a register, and data between memories. The available addressing means is determined depending on the type of a register for data transfer, double transfer and transfer accompanied by an operation. All addressing is performed in units of words.

Addressing modes

М	ode	Mnemonic	Effective address	Register update	Description
	irect essing	(imm16)	imm16	Not updated	16-bit direct addressing
	AD0	(Xk + + 1) (Xk + + 0) (Xk 1) (Xk + + Y0)	Xk Xk Xk Xk	+1 Not updated -1 Y0	Xk can be assigned X0, X1, X2 and X3.
	AD1	(Xm + + 3) (Xm + + 2) (Xm + + 1) (Xm + + 0) (Xm 1) (Xm 2) (Xm 3) (Xm + + Y1)	Xm Xm Xm Xm Xm Xm Xm Xm	+3 +2 +1 Not updated -1 -2 -3 Y1	Xm can be assigned X4, X5 and X6.
Indirect addressing		[BV+X7 + + 3] [BV+X7 + + 2] [BV+X7 + + 1] [BV+X7 + + 0] [BV+X7 1] [BV+X7 2] [BV+X7 3] [BV+X7 + + Y1]	BV+X7 BV+X7 BV+X7 BV+X7 BV+X7 BV+X7 BV+X7	+3 +2 +1 Not updated -1 -2 -3 Y1	For circular addressing, only X7 can be used.
lhdi	AD2	(BP+disp7) (Xn + + 2) (Xn + + 1) (Xn + + 0) (Xn 1) (Xn 2) (Xn 3) (Xn + + Y0) (Xn + + Y1) [BV+Xn + + 2] [BV+Xn + + 0] [BV+Xn 1] [BV+Xn 2] [BV+Xn + + Y0] [BV+Xn + + Y0] [BV+Xn + + Y1]	BP+disp7 Xn BV+Xn	Not updated +2 +1 Not updated -1 -2 -3 Y0 Y1 +2 +1 Not updated -1 -2 -3 Y0 Y1	Xn can be assigned X0, X1, X2, X3, X4, X5, X6 and X7. disp7 is signed 7 bits.

[] : Indicates circular addressing.

AD0: For "AD0," you cannot specify circular addressing.

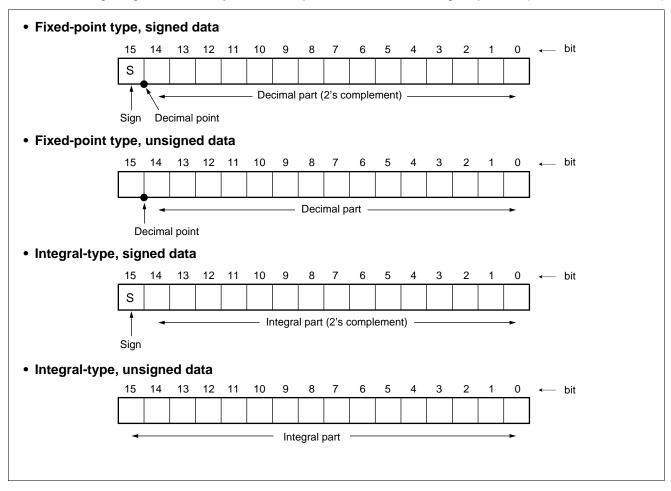
AD1: For "AD1," circular addressing mode is set automatically when "X7" is selected as the address register. With "0" set in the "MD" and "BV" registers, the same operation as ordinary addressing is performed even if "X7" is selected as the address register.

AD2: disp7 in "AD2" is signed 7 bits.

■ BASIC CONFIGURATION OF THE DATA OPERATION SECTION

1. Data Format

Integral type and fixed-point data can be handled regardless of whether the data is signed or unsigned. For signed data, the most significant bit indicates a sign. A number of 1 indicates negative data, which is expressed by 2's complement. The decimal point for fixed-point type data is located between the sign bit (bit 14) and its right bit (bit 15). When the accumulator value resulting from execution of a multiplication instruction is transferred to a 16-bit length register or memory, the decimal point is returned to the original position (between bits 14 and 15).



Since a value is handled in 2's complement format for addition and subtraction, no distinction is made in the result of an operation by the above four data format. Since, for multiplication, the result of an operation varies with whether data is signed or unsigned, three combinations of "signed data x signed data," "signed data x unsigned data," and "unsigned data x unsigned data" exist for multiplication instructions.

For the fixed-point type and the integral type, the result of multiplication varies with the decimal point position. When fixed-point type data is multiplied, the result of the operation is stored into the accumulator with one bit shifted to the left in comparison with integral type data. The "ITG" bit in the status register is used to switch between the fixed-point type and the integral type. With this bit set at 0, an operation is executed in the fixed-point type format.

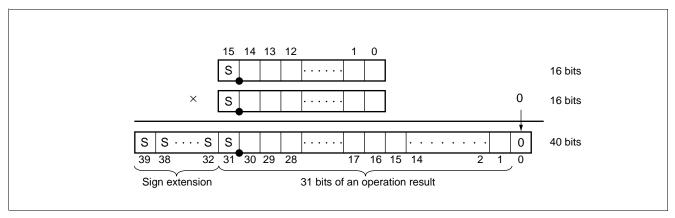
2. Multiplication in Fixed-point Type Mode

With the "ITG" bit in the status register set at 0, fixed-point type mode is set up, and multiplication is executed in the following format. You can use ordinary mode and NOG mode in which the guard bit is not used.

(1) Ordinary Mode

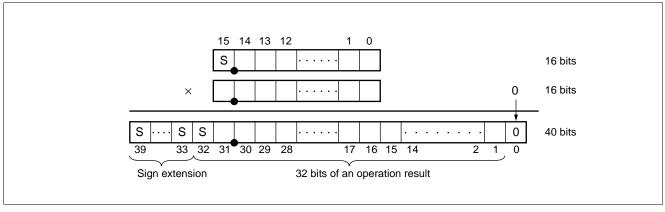
• Fixed-point type multiplication (signed data × signed data)

31 bits of the result of a signed operation are stored into bits 1 to 31 in the accumulator shifted to the left by one bit. "0" is set to bit 0, with the same value as at bit 31 set to bits 32 to 39.



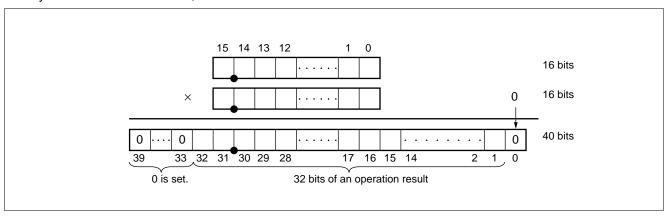
• Fixed-point type multiplication (signed data × unsigned data)

32 bits of the result of a signed operation are stored into bits 1 to 32 in the accumulator shifted to the left by one bit. "0" is set to bit 0, with the same value as at bit 32 set to bits 33 to 39.



• Fixed-point type multiplication (unsigned data × unsigned data)

32 bits of the result of an unsigned operation are stored into bits 1 to 32 in the accumulator shifted to the left by one bit. "0" is set to bit 0, and bits 33 to 39.

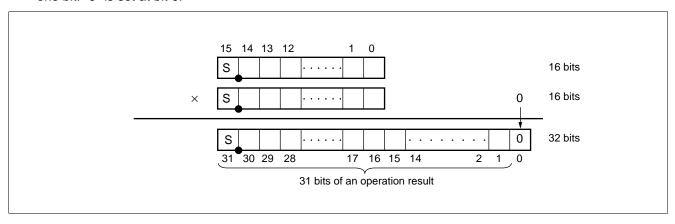


(2) NOG Mode

In this mode, the CX and DX registers are handled as a 32-bit accumulator in which detected overflow is clipped.

• Fixed-point type multiplication (signed data x signed data)

31 bits of the result of a signed operation are stored into bits 1 to 31 in the accumulator shifted to the left by one bit. "0" is set at bit 0.



■ INTERRUPT

A software interrupt and a hardware interrupt are available. Interrupts are assigned specified types of priority. When interrupts occur concurrently, an interrupt with higher priority is executed earlier.

Priority	Soft/hard	Interrupt type	Interrupt branch destination	Cause of an interrupt
1	Hard	RST	0xFFFE	Hardware reset External reset signal input
2	Hard	BREAK	0×0002*	Setup of emulator operation mode External break signal input
	Soft	TRAP		Setup of emulator operation mode Software (TRAP instruction)
3	Soft	V1	0xFFFC	Occurrence of arithmetic operation overflow (V1)
4		V3	0×FFFA	Occurrence of arithmetic operation overflow (V3)
5	Hard	DMA0	_	DMA0 signal input (for data input)
6		DMA1	_	DMA1 signal input (for data input)
7		DMA2	_	DMA2 signal input (for data output)
8		DMA3	_	DMA3 signal input (for data output)
9		INT0	0×FFF8	SDOME interrupt signal input
10		INT1	0×FFF6	External interrupt signal input (INT1)
11		INT2	0×FFF4	External interrupt signal input (INT2)
12		INT3	0xFFF2	External interrupt signal input (INT3)
13		INT4	0×FFF0	External interrupt signal input (INT4)
14		INT5	0xFFEE	External interrupt signal input (INT5)
15		INT6	0xFFEC	External interrupt signal input (INT6)
16		INT7	0xFFEA	External interrupt signal input (INT7)

^{* :} Memory space for a debug instruction

Notes: • Emulator operation mode is set by a hardware interrupt resulting from external break signal input and by a software interrupt by the TRAP instruction.

• Any interrupts other than a reset are disabled during downloading.

■ INSTRUCTIONS

N 4	0				Flag o	Tag change			
Mnemonic	Operation	overview	N	Z	С	V1	V2	٧3	
ABS	Absolute value calculation	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	0	\(\)	_	\(\)	↑	\(\)	
ADD	Addition	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\$	\$	\uparrow	\(\)	
ADD	Addition with transfer		1	\(\)	\(\)	\$	1	\(\)	
ADDC	Addition with carry	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	1	\(\)	\$	\(\)	\uparrow	\(\)	
ADSB	Addition and subtraction	A0, A1, B0, B1	1	\$	\$	\$	1	-	
ADX	Address register addition	Xn ← Xn + Immediate value	_	-	-	-	-	-	
AND	Logical AND	A0, A1, B0, B1, C0, C1, D0, D1	\$	1	-	-	_	_	
	Logical AND	ST	\downarrow	\downarrow	\downarrow	\downarrow	\downarrow	\downarrow	
ASL	MSB □□ ···· □□ ← 0 C ←	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\$	\(\)	\uparrow	\(\)	
ASL	MSB □□ ···· □□ ← 0 C → Shift with transfer	CX , DX reg \leftrightarrow (AD1)	\$	\(\)	\(\)	\(\)	↑	\(\)	
ASR	$MSB \leftarrow \square\square \cdots \square\square \to C$	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\(\)	\(\)	↑	\(\)	
BRcc	Conditional relative branch		_	_	_	_	_	_	
CALL	Subroutine jump		_	_	_	_	_	_	
CMGT	Transfer with (major) comparison conditions	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\$	\(\)	\uparrow	\(\)	
CMLT	Transfer with (minor) comparison conditions	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\$	\(\)	\uparrow	\(\)	
CMP	Comparison	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	1	\(\)	\$	\(\)	\uparrow	\(\)	
DO	Block repetition	RPC/imm 10	-	-	-	_	-	_	
DSTP	Division support	AX, BX, CX, DX/A0, A1, B0, B1, C0, C1, D0, D1	\$	\(\)	-	\(\)	\(\)	\(\)	
JPC0	Conditional absolute branch		_	_	_	_	_	_	
JPC1	Conditional absolute branch		_	_	_	_	_	_	
JUMP	Absolute branch		_	_	_	_	_	_	
LSL	C ← □□ ···· □□ ← 0	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\$	-	-	-	
LSR	$0 \to \square\square \cdots \square \square \to C$	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	1	\(\)	-	_	_	

Mnemonic	Onavation	ovorviow			Flag	hange	•	
winemonic	Operation	overview	N	Z	С	V1	V2	V3
MOV	Data transfer or duplicate transfer	Inter-register transfer REG ↔ REG Transfer between a memory and a register MEM ↔ REG Duplicate transfer B0 ← (AD0), A1 ← (AD1) B0 ← (AD0), B1 ← (AD1) Immediate value transfer to a register REG ← Immediate value Inter-memory transfer (AD0) ← (AD1)	-	-	-	-	-	-
MOVT	Duplicate transfer to the accumulator	CX, DX ← (AD1)	_	-	_	-	-	_
MRD	Signed product addition	A0, A1,B0, B1/CX, DX	\$	\updownarrow	0	\updownarrow	\uparrow	\updownarrow
MRD	Signed product addition with duplicate transfer	$ \begin{array}{c} acc \leftarrow acc - A0 \times A1 \\ A0 \leftarrow (AD0), A1 \leftarrow (AD1) \\ acc \leftarrow acc - B0 \times B1 \\ B0 \leftarrow (AD0), B1 \leftarrow (AD1) \end{array} $	\$	\$	0	\$	1	\$
MRDS	Signed and unsigned product addition	A0, A1, B0, B1/CX, DX	\$	\(\)	0	\(\)	1	-
MRDU	Unsigned and unsigned product addition	A0, A1, B0, B1/CX, DX	1	1	0	\$	1	-
MSM	Signed product addition	A0, A1, B0, B1/CX, DX	\$	1	0	\$	1	\$
MSM	Signed product addition with duplicate transfer	$ \begin{array}{c} acc \leftarrow acc + A0 \times A1 \\ A0 \leftarrow (AD0), A1 \leftarrow (AD1) \\ acc \leftarrow acc + B0 \times B1 \\ B0 \leftarrow (AD0), B1 \leftarrow (AD1) \end{array} $	\$	\$	0	\$	1	\$
MSM	Signed product addition with transfer	$acc \leftarrow acc + (A0 \text{ or } A1)$ × A1 reg \leftrightarrow (AD1)	1	\(\)	0	\(\)	1	\(\)
MSMS	Signed and unsigned product addition	A0, A1, B0, B1/CX, DX	\$	\$	0	\$	1	-
MSMS	Signed and unsigned product addition with duplicate transfer	$ \begin{array}{c} acc \leftarrow acc + A0 \times A1 \\ A0 \leftarrow (AD0), A1 \leftarrow (AD1) \\ acc \leftarrow acc + B0 \times B1 \\ B0 \leftarrow (AD0), B1 \leftarrow (AD1) \end{array} $	\$	\(\)	0	\$	1	_
MSMU	Unsigned and unsigned product addition	A0, A1, B0, B1/CX, DX	\$	\(\)	0	\$	↑	_
MSMU	Unsigned and unsigned product addition with duplicate transfer	$ \begin{array}{c} acc \leftarrow acc + A0 \times A1 \\ A0 \leftarrow (AD0), A1 \leftarrow (AD1) \\ acc \leftarrow acc + B0 \times B1 \\ B0 \leftarrow (AD0), B1 \leftarrow (AD1) \end{array} $	\$	\$	0	\$	1	_

Mnomania	0	avamiau.	Flag change					
Mnemonic	Operation	overview	N	Z	С	V1	V2	V3
MUL	Signed multiplication	A0, A1, B0, B1, C0, C1, D0, D1/CX, DX	\$	\(\)	-	-	-	\(\)
MUL	Signed multiplication with duplicate transfer	$\begin{array}{c} acc \leftarrow A0 \times A1 \\ A0 \leftarrow (AD0), A1 \leftarrow (AD1) \\ acc \leftarrow B0 \times B1 \\ B0 \leftarrow (AD0), B1 \leftarrow (AD1) \end{array}$	\$	\$	-	-	-	\$
MUL	Signed multiplication with transfer	$acc \leftarrow (A0 \text{ or } A1) \times A1$ reg $\leftrightarrow (AD1)$	\$	\(\)	-	-	-	\(\)
MULS	Signed and unsigned multiplication	A0, A1, B0, B1, C0, C1, D0, D1/CX, DX	\$	\(\)	-	-	-	-
MULS	Signed and unsigned multiplication with duplicate transfer	$ \begin{array}{c} acc \leftarrow A0 \times A1 \\ A0 \leftarrow (AD0), A1 \leftarrow (AD1) \\ acc \leftarrow B0 \times B1 \\ B0 \leftarrow (AD0), B1 \leftarrow (AD1) \\ \end{array} $	\$	\$	_	_	_	_
MULU	Signed and unsigned multiplication	A0, A1, B0, B1, C0, C1, D0, D1/CX, DX	\$	\(\)	-	-	-	_
MULU	Signed and unsigned multiplication with duplicate transfer	$ \begin{array}{c} acc \leftarrow A0 \times A1 \\ A0 \leftarrow (AD0), A1 \leftarrow (AD1) \\ acc \leftarrow B0 \times B1 \\ B0 \leftarrow (AD0), B1 \leftarrow (AD1) \end{array} $	\$	\$	_	-	-	_
MVcc	Conditional transfer	Inter-register transfer REG ↔ REG	_	-	-	-	-	_
NOT	Logical NOT	A0, A1, B0, B1, C0, C1, D0, D1	\$	\(\)	-	-	-	-
NEG	2's complement operation	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\(\)	\(\)	↑	\(\)
NOP	None executed		_	-	_	-	_	_
OR	Logical OR	A0, A1, B0, B1, C0, C1, D0, D1	\$	\(\)	-	-	-	_
		ST	1	1	1	1	1	1
POP	Return of a register from the stack		-	-	-	-	-	-
PUSH	Saving of a register to the stack		_	-	-	-	-	-
REGU	Auxiliary normalization operation	CX, DX	-	1	-	-	-	_
REP	Repeated execution of the subsequent instruction	RPC/imm 10	-	-	-	-	-	_
REP2	Repeated execution of the subsequent instruction	RPC2/imm 10	-	-	-	-	-	_
RET	Return from a subroutine		-	-	_	_	_	_
RET1	Return from an interrupt routine		-	-	-	-	-	_

(Continued)

Mnemonic	Operation	ovorviow	Flag change N Z C V1 V2 V3 - ↑					
Willemonic	Operation	Overview	N	Z	С	V1	V2	V3
RGLT	Auxiliary search for the minimum normalized value	CX, DX	_	1	-	-	-	_
RVL	Reverse shift	A0, A1, B0, B1, C0, C1, D0, D1	1	\(\)	\(\)	-	-	-
SLP	Standby status		_	_	_	_	_	_
STLD	Store and load	$(AD0) \leftarrow A0, A0 \leftarrow (AD1)$ $(AD0) \leftarrow A1, A1 \leftarrow (AD1)$ $(AD0) \leftarrow CX, CX \leftarrow (AD1)$ $(AD0) \leftarrow DX, DX \leftarrow (AD1)$	_	_	_	_	_	_
SBAD	Subtraction and addition	A0, A1, B0, B1	1	1	\$	1	1	-
SUB	Subtraction	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\(\)	\(\)	↑	\$
SUB	Subtraction with transfer	acc ← acc − A1 reg ← (AD1)	\$	\(\)	\$	\(\)	1	\$
SUBC	Subtraction with carry	A0, A1, B0, B1, C0, C1, D0, D1, AX, BX, CX, DX	\$	\(\)	\$	\(\)	1	\$
XOR	Exclusive logical OR	A0, A1, B0, B1, C0, C1, D0, D1	1	\(\)	-	-	-	_

[Flag indications]

 \updownarrow : Set or reset by an operation

 \downarrow : Not changed or reset by an operation

-: Not changed by an operation

 \uparrow : Not changed or reset by an operation

0: Reset by an operation

■ BOOT

1. BOOT Mode

BOOT mode supports the following functions.

- Ordinary BOOT function (Booting the instruction RAM (48 kwords)/the table RAM (16 kwords))
- Simplified BOOT function (Booting some instruction RAMs)

2. Setting BOOT Mode

Only single chip mode is available.

(1) Command Setup

Load the ERAM area (FFE0H to FFE3H: PAGE1-0 = 11) with the following contents during booting.

• Address FFE0: Command contents

0001н to 000Вн : Reserved

000C_H : Simplified booting

000D_H to 0010_H : Reserved Others : Ordinary booting

• Address FFE1: Start address

Specify the start address of a program to be booted during simplified booting.

Address FFE2: Size

Specify the program size of a program to be booted during simplified booting.

Address FFE3: Execution start address

Specify an execution start address after completion of simplified booting.

(2) Ordinary BOOT function (Command = other than 0001H to 0010H)

The ordinary BOOT function loads a full-word program (48 kwords) and table data (16 kwords), then moves execution to the user program (jump to address FFFE) or ICE (jump to address 0002).

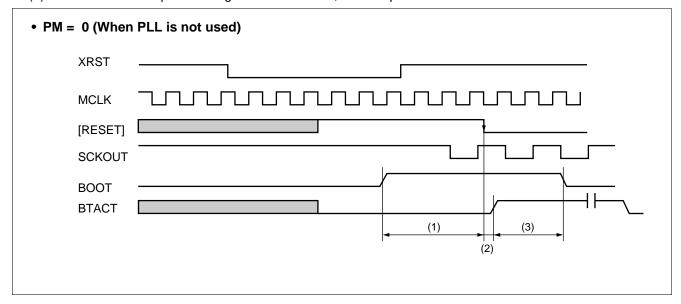
(3) Simplified BOOT function (Command = 000CH)

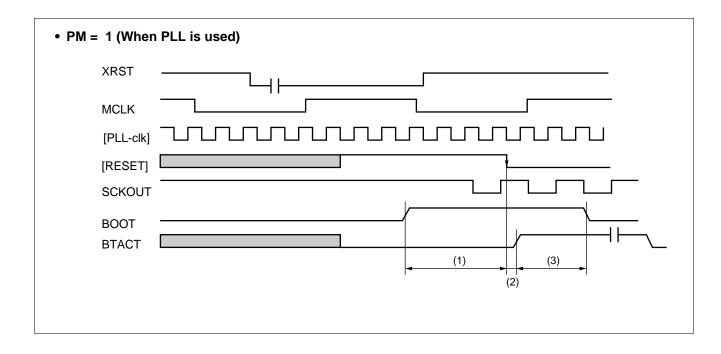
The Simplified BOOT function loads and executes a program of 48 k or fewer words. It also sets loaded start address (FFE1H), the number of program words (FFE2H), and execution start address (FFE3H).

3. BOOT Timing

Performing BOOT processing requires satisfaction of the following operation.

- (1) Take setup of two or more MCLK clocks from a fall rising edge.
- (2) Fetch information about the BOOT pin at a fall rising edge, and the BTACT pin will be set at "H".
- (3) Reset the BOOT pin at least two MCLK clocks after a fall edge observed at the BTACT pin.
- (4) When the BTACT pin is changed from "H" to "L", BOOT operation is terminated.





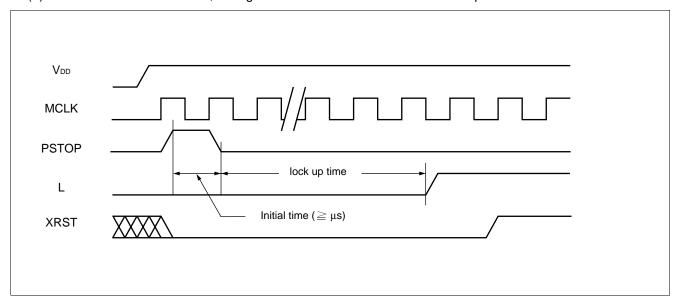
■ PLL

1. PLL operation

Performing this DSP operation using PLL requires satisfaction of the following operation.

When using PLL, set the PSTOP pin at "H" for 1 μ sec or more for a reset, then at "L", and wait for lockup time or more time.

- (1) Take enough time for MCLK input and for lockup at the PLL operation state with PSTOP equal to "L".
- (2) Hold the DSP reset state until PLL is locked. (XRST = "L")
- (3) When PLL is locked, the "L" pin goes "H".
- (4) After PLL has been locked, change XRST from "L" to "H" to start DSP operation.



2. PLL standards

Input clock (MHz)	Look up time (μs)	Remarks
20 to 25	200	When PLL is used

■ ELECTRICAL CHARACTERISTICS

1. Absolute Maximum Ratings

(Vss = 0 V)

Parameter	Symbol	Condition	Value		Unit	Remarks
Faranietei	Syllibol	Condition	Min.	Max.	Offic	Remarks
Power supply voltage	V _{DD}	V _{DD} - V _{SS}	Vss - 0.5	4.0	V	
Input voltage	Vı	_	Vss - 0.5	V _{DD} + 0.5	V	Input pin
Output voltage	Vo	_	Vss - 0.5	V _{DD} + 0.5	V	Output pin BUS pin
Maximum output current	lo	Vo = VDD	_	14	mA	Output drive pin
Maximum output current	lo	Vo = 0 V	_	-14	mA	(lol) 4 mA
Storage temperature	Tstg	_	-65	+150	°C	Ceramic package

WARNING: Semiconductor devices can be permanently damaged by application of stress (voltage, current, temperature, etc.) in excess of absolute maximum ratings. Do not exceed these ratings.

2. Recommended Operating Conditions

(Vss = 0 V)

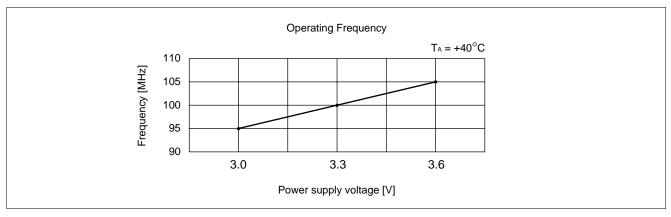
Parameter	Symbol		Value		Unit	Pomarks
raiailletei	Symbol	Min.	Тур.	Max.	Onit	Remarks V _{DD}
Power supply voltage	V _{DD}	3.0	3.3	3.6	V	V _{DD}
"H" level input voltage	VIH	0.65 V _{DD}	_	V _{DD} + 0.3	V	
"L" level output voltage	VIL	Vss	_	0.25 V _{DD}	V	
Ambient temperature	TA	0	_	+40	°C	

WARNING: The recommended operating conditions are required in order to ensure the normal operation of the semiconductor device. All of the device's electrical characteristics are warranted when the device is operated within these ranges.

Always use semiconductor devices within their recommended operating condition ranges. Operation outside these ranges may adversely affect reliability and could result in device failure.

No warranty is made with respect to uses, operating conditions, or combinations not represented on the data sheet. Users considering application outside the listed conditions are advised to contact their FUJITSU representatives beforehand.

3. Operating Frequency



4. DC Characteristics

 $(V_{DD} = 3.0 \text{ to } 3.6 \text{ V}, \text{Vss} = 0 \text{ V}, \text{TA} = 0^{\circ}\text{C to } +40^{\circ}\text{C})$

Parameter	Symbol	Condition		Value		Unit
Farameter	Symbol	Condition	Min.	Тур.	Max.	Onit
	Idds	Standby mode*1	_	50	_	μΑ
Power supply voltage	IDD	Ordinary operation mode	_	62	_	mA
"H" level input voltage	ViH	_	0.65 V _{DD}	_	V _{DD}	V
"L" level input voltage	VIL	_	Vss	_	0.25 Vss	V
"H" level output voltage	Vон	Iон = −4mA	V _{DD} - 0.5	_	V _{DD}	V
"L" level output voltage	Vol	IoL = 4mA	Vss	_	0.4	V
Input leakage current*2	lu	$V_1 = 0 - V_{DD}$	-5	_	5	μΑ
(Tri-state pin)	ILZ	VI = U - VDD	- 5	_	5	μΑ
Pull-up/pull-down resistor	RP	_	25	50	200	kΩ
Output current	lo*3	State	Vo = VDD	_	Vo = 0 V	mA
(Shorting circuit)	10 ~	Normal/IoL = 4 mA	+60	_	-60	mA

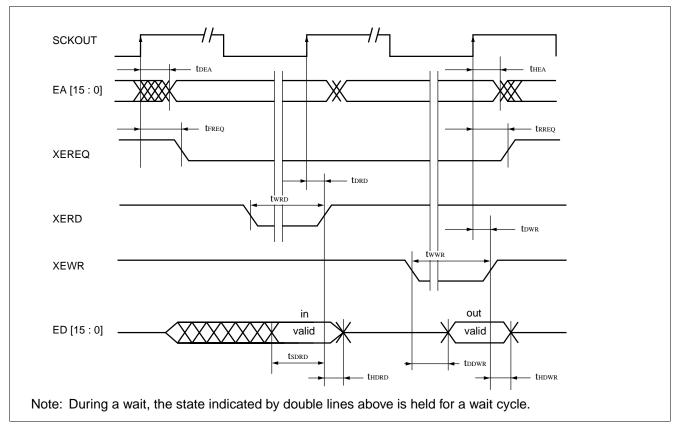
^{*1:} The memory is set at the standby state with $V_{IH} = V_{DD}$ and $V_{IL} = V_{SS}$.

^{*2:} With the input pin provided with a pull-up or pull-down resistor, the standard value may be exceeded.

^{*3:} Maximum supply current at the output section, and the VDD or Vss circuit

5. AC Characteristics

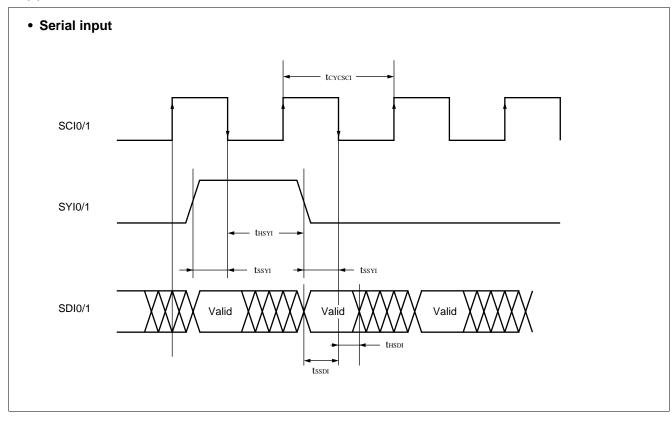
(1) ERAM Interface

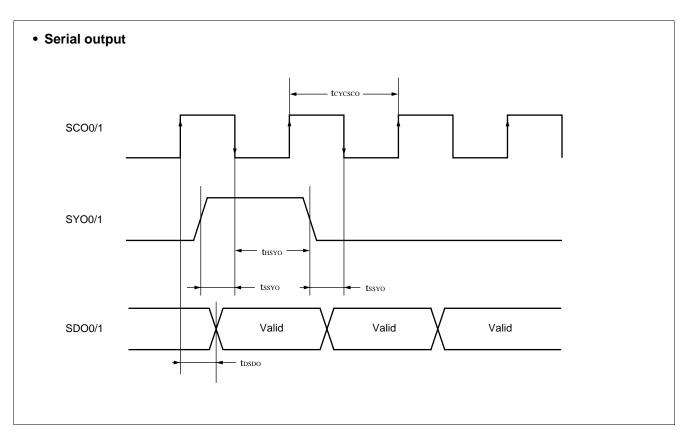


(V_{DD} = 3.0 V to 3.6 V, T_A = 0° C to $+40^{\circ}$ C, output pin load = 50 pF)

Parameter	Symbol Pin name	Din nama		l lmi4		
raiailletei	Symbol	riii name	Min.	Тур.	Max.	Unit
EA output delay	t DEA	EA	_	_	6.2	ns
EA hold time	tHEA	EA	2.6	_	_	ns
XEREQ falling delay	t FREQ	XEREQ	_	_	5.5	ns
XEREQ rising delay	trreq	XEREQ	_	_	4.2	ns
XERD rising delay	t DRD	XERD	_	_	1.0	ns
XERD "L" pulse width	twrd	XERD	5.8	_	_	ns
XEWR rising delay	towr	XEWR	_	_	2.5	ns
XEWR "L" pulse width	twwr	XEWR	4.2	_	_	ns
ED setup time for XERD	tsdrd (in)	ED	10.3	_	_	ns
ED hold time for XERD	thdrd (in)	ED	1.5	_	_	ns
ED delay time for XEWR	tddwr (out)	ED	_	_	8.5	ns
ED hold time for XEWR	thowr (out)	ED	0.3	_	_	ns

(2) Serial I/O Interface

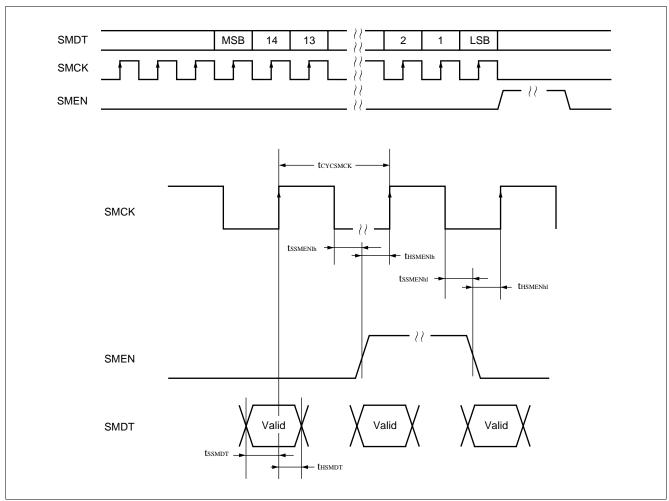




(V_{DD} = 3.0 V to 3.6 V, T_A = 0° C to $+40^{\circ}$ C, output pin load = 50 pF)

Parameter	Symbol	Pin name		Value		
Farameter	Tarameter Symbol Till	riii iiaiiie	Min.	Тур.	Max.	Unit
Serial input clock cycle	tcycsci	SCI [1:0]		≧ 500		ns
SYI signal setup time	t ssti	SYI [1:0]	2.1	_	_	ns
SYI signal hold time	thsyl	SYI [1:0]	1.4	_		ns
SDI signal setup time	tssdi	SDI [1:0]	1.5	_	_	ns
SDI signal hold time	t HSDI	SDI [1:0]	2.0	_		ns
Serial output clock cycle	tcycsco	SCO [1:0]		≧ 500		ns
SYO signal setup time	tssyo	SYO [1:0]	2.2	_	_	ns
SYO signal hold time	thsyo	SYO [1:0]	1.4	_	_	ns
SDO signal output delay	tospo	SDO[1:0]	_	_	5.6	ns

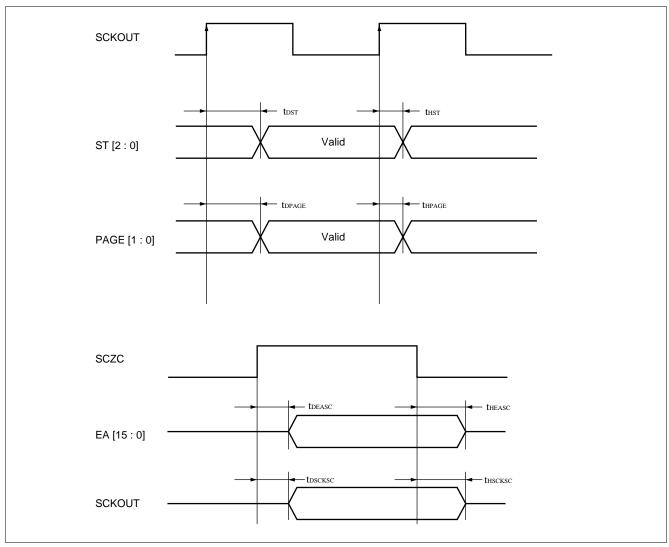
(3) SMODE



 $(V_{DD} = 3.0 \text{ V to } 3.6 \text{ V}, T_A = 0^{\circ}\text{C to } +40^{\circ}\text{C}, \text{ output pin load} = 50 \text{ pF})$

Parameter	Symbol Pin nar	Pin name	Value			Unit
	Syllibol	Fili liaille	Min.	Тур.	Max.	Oilit
Serial input clock cycle	tcүсsмск	SMCK		≥ 500		ns
SMDT SMCK setup time	tssmdt	SMDT	0.8	_	_	ns
SMDT SMCK hold time	thsmdt	SMDT	1.8	_	_	ns
SMEN SMCK setup time	tssmenhl	SMEN	0.6	_	_	ns
SMEN SMCK hold time	tHSMENHI	SMEN	0.6	_	_	ns
SMEN SMCK setup time	tssmenih	SMEN	0.6	_	_	ns
SMEN SMCK hold time	tHSMENIh	SMEN	0.8	_	_	ns

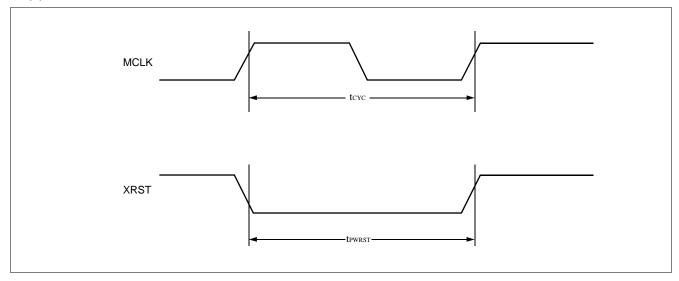
(4) PLL and Others



 $(V_{DD} = 3.0 \text{ V to } 3.6 \text{ V}, T_A = 0^{\circ}\text{C to } +40^{\circ}\text{C})$

Parameter	Symbol	Symbol Pin name	Value			Unit
Parameter	Syllibol		Min.	Тур.	Max.	Unit
ST output delay	t DST	ST [2:0]	_	_	3.3	ns
ST hold time	t HST	ST [2:0]	0.8	_	_	ns
PAGE output delay	t DPAGE	PAGE [1:0]	_	_	5.3	ns
PAGE hold time	t HPAGE	PAGE [1:0]	1.3	_	_	ns
EA output delay for SCZC	t DEASC	EA [15 : 0]	_	_	5.4	ns
EA hold time for SCZC	t HEASC	EA [15 : 0]	2.2	_	_	ns
EA output delay for SCZC	toscksc	SCKOUT	_	_	3.2	ns
EA hold time for SCZC	thscksc	SCKOUT	1.1	_	_	ns

(5) MCLK, XRST



(V_{DD} = 3.0 V to 3.6 V, T_A = 0° C to + 40° C)

Parameter	Symbol	Din nama		Value		Unit	Remarks
Parameter	Symbol	Pin name	Min.	Тур.	Max.	Onit	Remarks
MCLK cycle (when PLL is used)	fcyc	MCLK	20	_	25	MHz	*
MCLK cycle (when PLL is not used)	fcyc	MCLK	_	_	160	MHz	*

^{* :} Input the MCLK cycle value so that the MCLK duty-cycle becomes 50% \pm 5%.

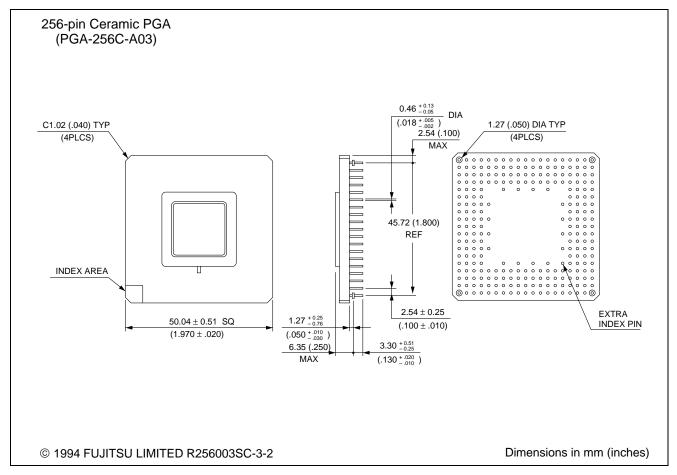
Parameter	Symbol Pi	ymbol Pin name	Value			Unit
i didiletei	Symbol	i iii iiaiiie	Min.	Тур.	Max.	Oille
XRST "L" pulse width	t pwrst	XRST	10tcyc*			ns

^{*:} $t_{CYC} = 1/f_{CYC}$

■ ORDERING INFORMATION

Part number	Package	Remarks
MB86330CR-ES	256-pin Ceramic PGA (PGA-256C-A03)	

■ PACKAGE DIMENSIONS



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